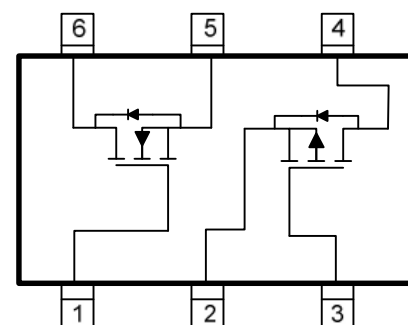
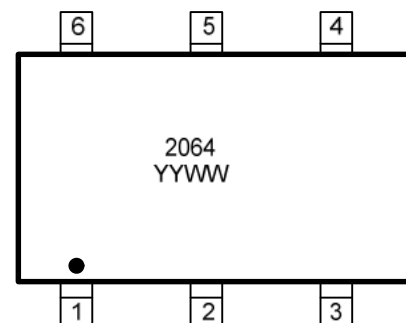


**WCM2064**
**N- and P-Channel Complementary, 20V,MOSFET**
[Http://www.sh-willsemi.com](http://www.sh-willsemi.com)

$V_{DS}$ (V)	Typical $R_{DS(on)}$ ( $\Omega$ )
N-Channel 20	0.034 @ $V_{GS}=4.5V$
	0.041 @ $V_{GS}=2.5V$
	0.050 @ $V_{GS}=1.8V$
P-Channel -20	0.083 @ $V_{GS}=-4.5V$
	0.110 @ $V_{GS}=-2.5V$
	0.145 @ $V_{GS}=-1.8V$


**SOT-23-6L**
**Descriptions**

The WCM2064 is the N-Channel and P-Channel enhancement MOS Field Effect Transistor as a single package for DC-DC converter or level shift applications, uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. Standard Product WCM2064 is Pb-free and Halogen-free.


**Pin configuration (Top View)**


2064 = Device Code

YYWW = Date Code

**Marking**
**Features**

- Trench Technology
- Supper high density cell design
- Excellent ON resistance
- Extremely Low Threshold Voltage
- Small package SOT-23-6L

**Applications**

- Driver: Relays, Solenoids, Lamps, Hammers
- Power supply converters circuit
- Load/Power Switching for portable device

**Order Information**

Device	Package	Shipping
WCM2064-6/TR	SOT-23-6L	3000/Tape&Reel

**Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	N-Channel	P-Channel	Unit	
$V_{DSS}$	Drain-to-Source Voltage	20	-20	V	
$V_{GSS}$	Gate-to-Source Voltage	$\pm 8$	$\pm 8$	V	
$I_D$	Continuous Drain Current <sup>a d</sup>	$T_A=25^\circ\text{C}$	4.4	-2.8	A
		$T_A=70^\circ\text{C}$	3.5	-2.2	
$I_{DM}$	Pulsed Drain Current <sup>c</sup>	16	-10	A	
$P_D$	Power Dissipation <sup>a d</sup>	$T_A=25^\circ\text{C}$	0.72		W
		$T_A=70^\circ\text{C}$	0.46		
$T_J$	Operation junction temperature	-55~150		$^\circ\text{C}$	
$T_{stg}$	Storage temperature range	-55~150		$^\circ\text{C}$	

**Thermal Resistance Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance <sup>a</sup>	$t \leq 10$ s	$R_{\theta JA}$	74	92	$^\circ\text{C/W}$
	Steady State		115	143	
Junction-to-Ambient Thermal Resistance <sup>b</sup>	$t \leq 10$ s	$R_{\theta JA}$	90	112	
	Steady State		138	172	
Junction-to-Case Thermal Resistance	Steady State	$R_{\theta JC}$	63	78	

a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

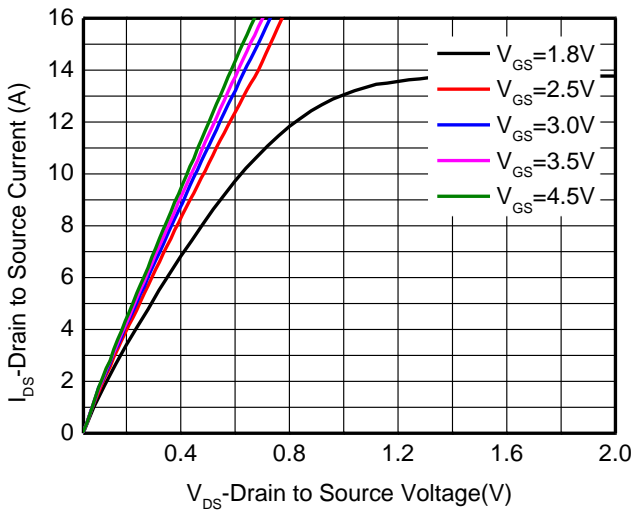
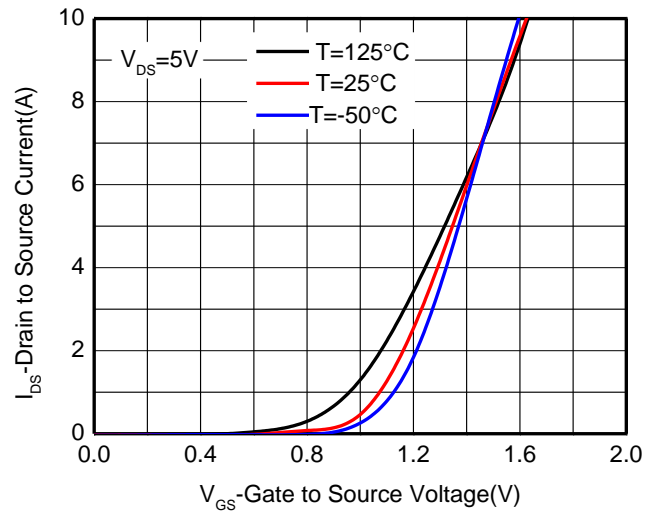
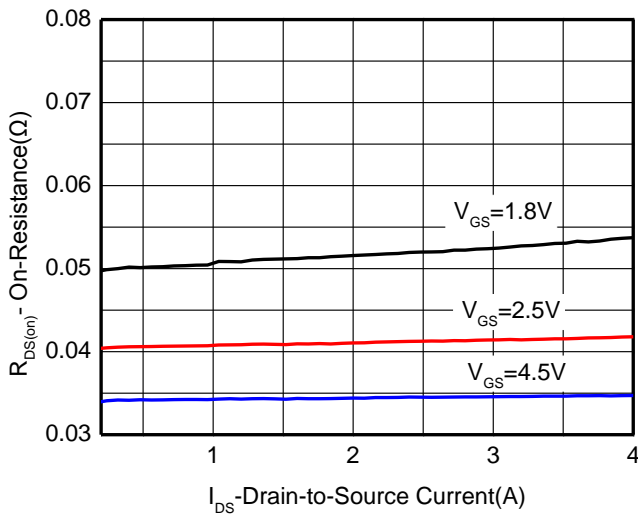
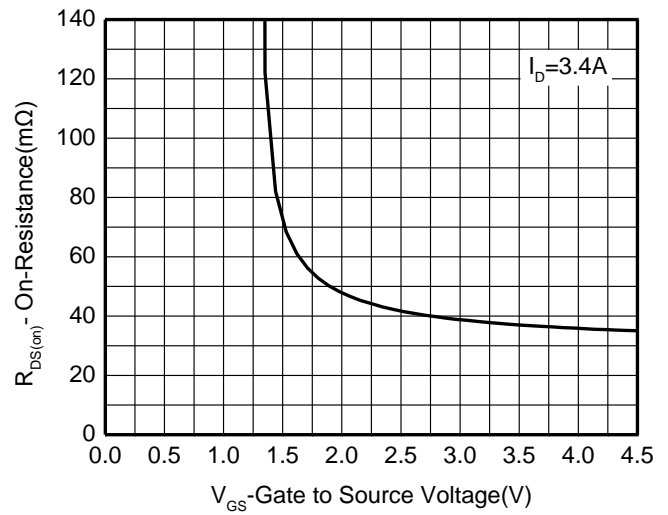
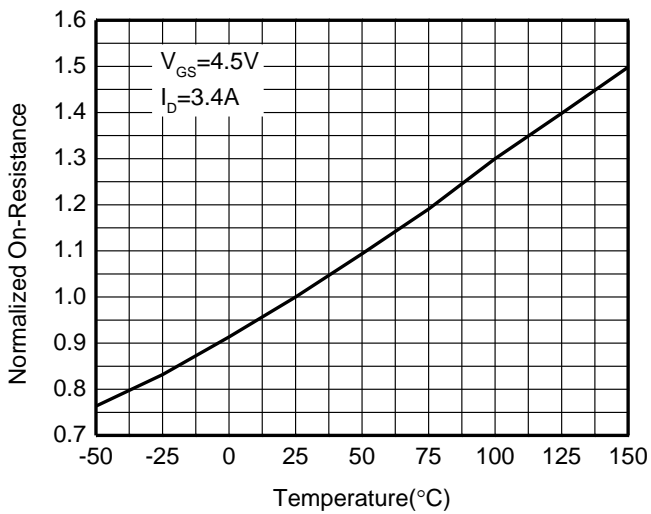
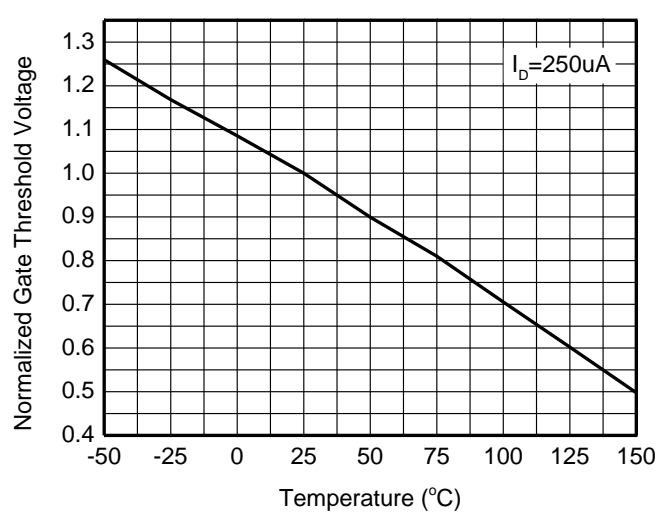
b Surface mounted on FR4 board using minimum pad size, 1oz copper

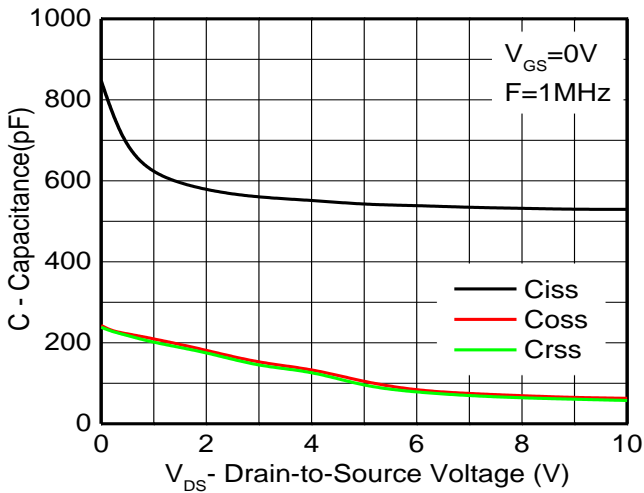
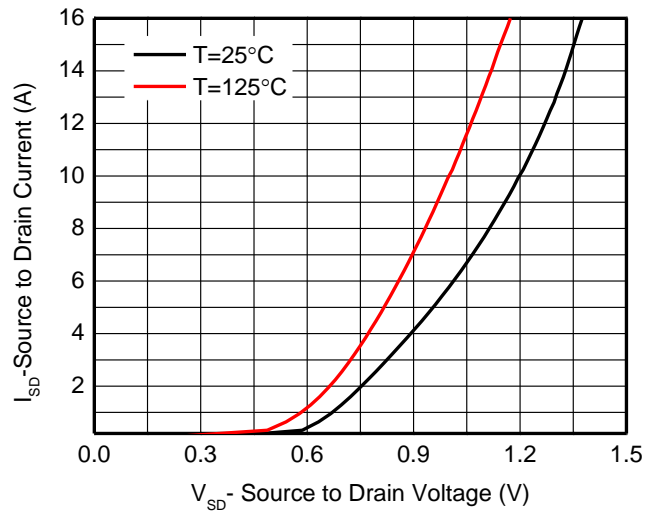
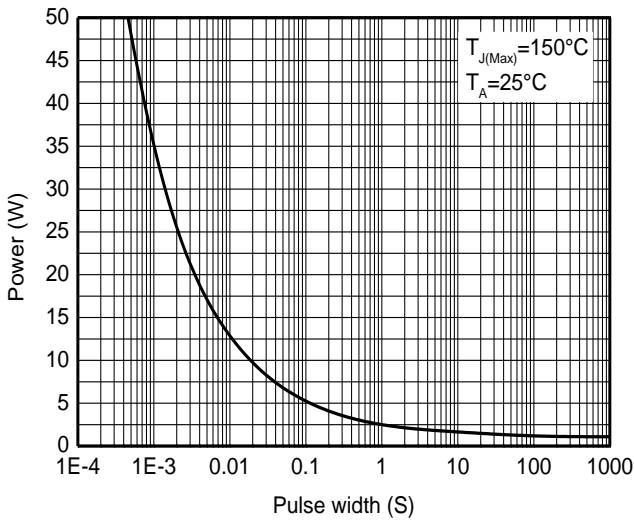
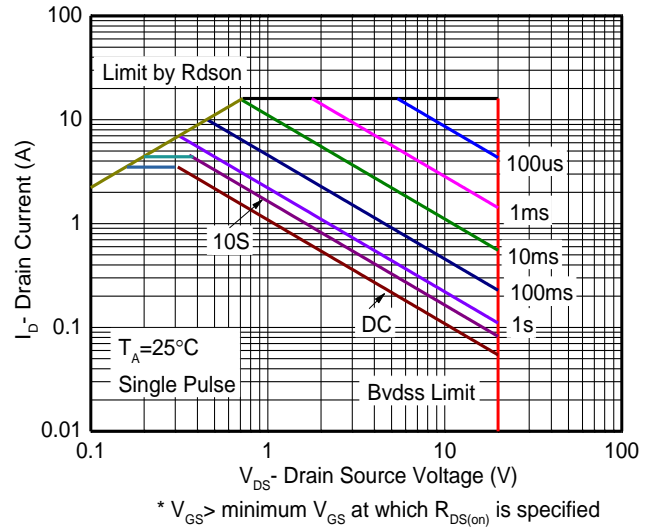
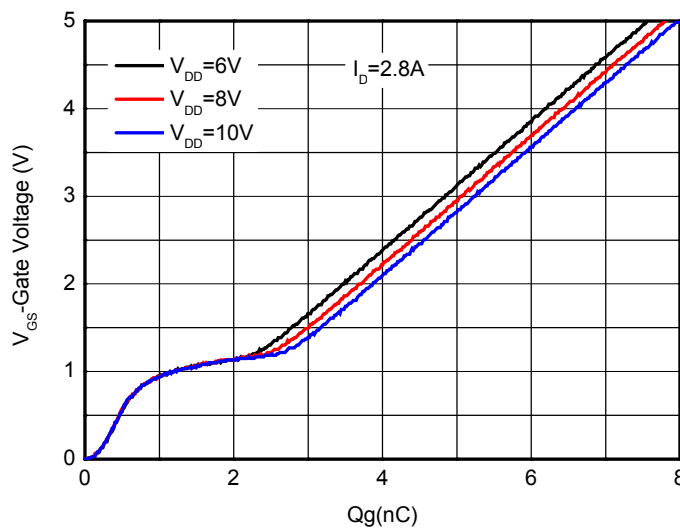
c Pulse width<380 $\mu\text{s}$ , Duty Cycle<2%

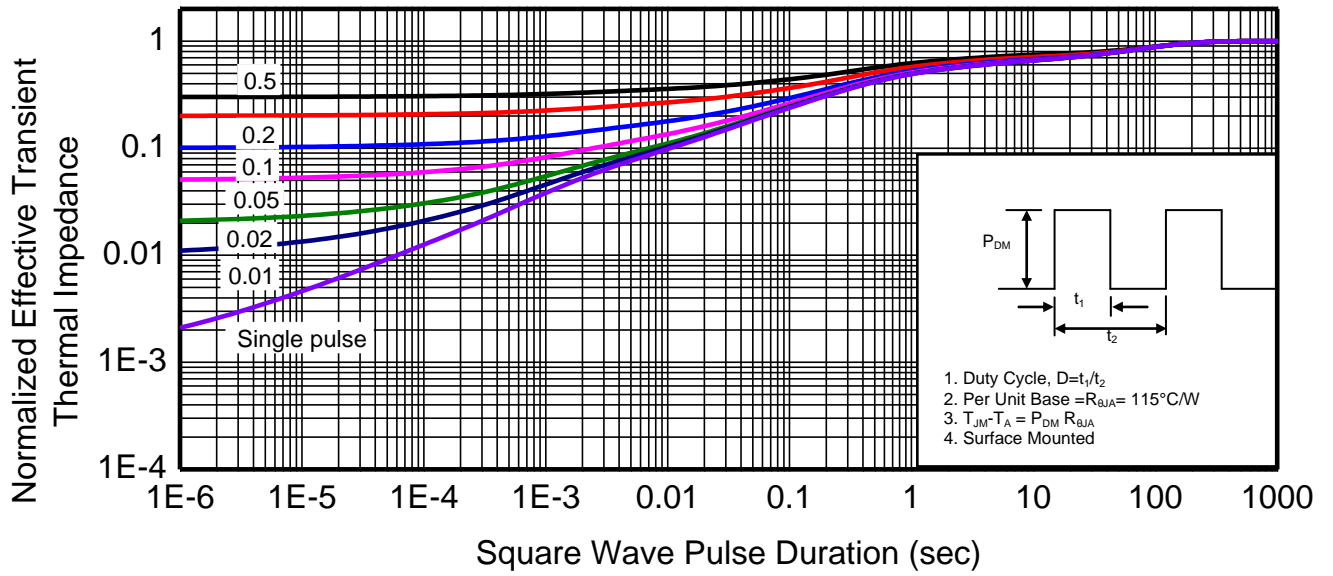
d Maximum junction temperature  $T_J=150^\circ\text{C}$ .

**Electronics Characteristics ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)**

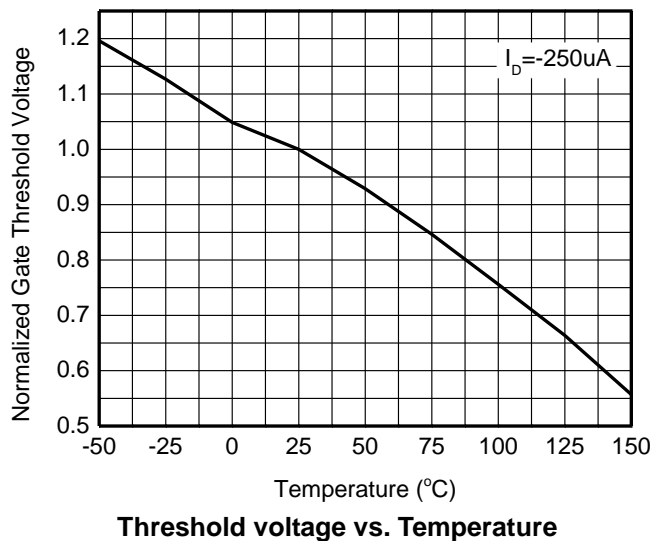
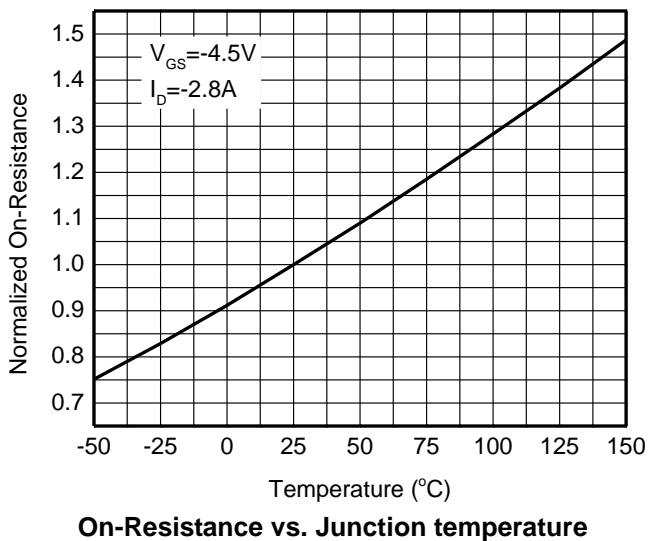
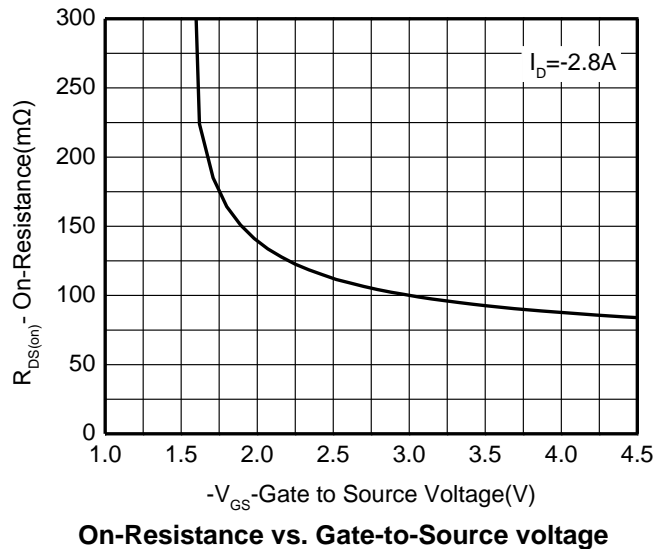
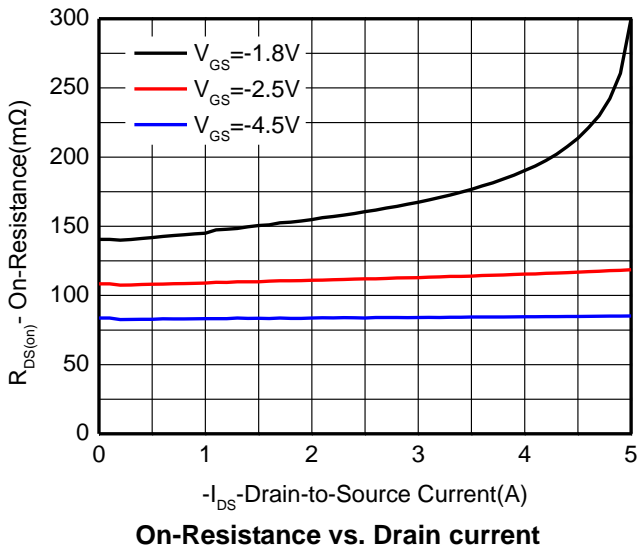
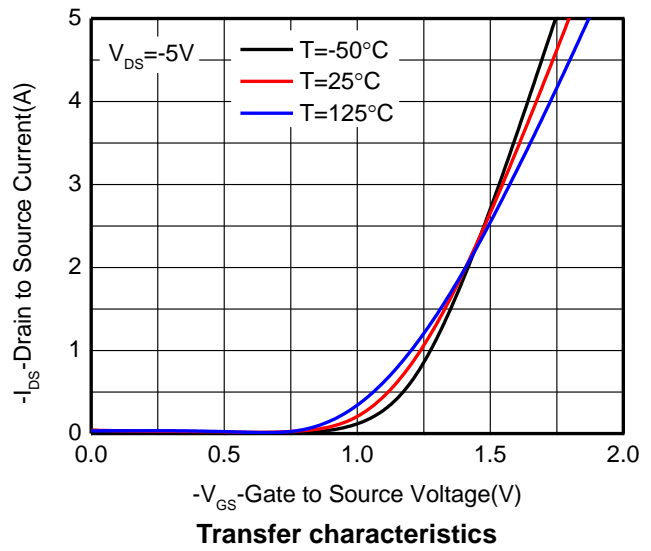
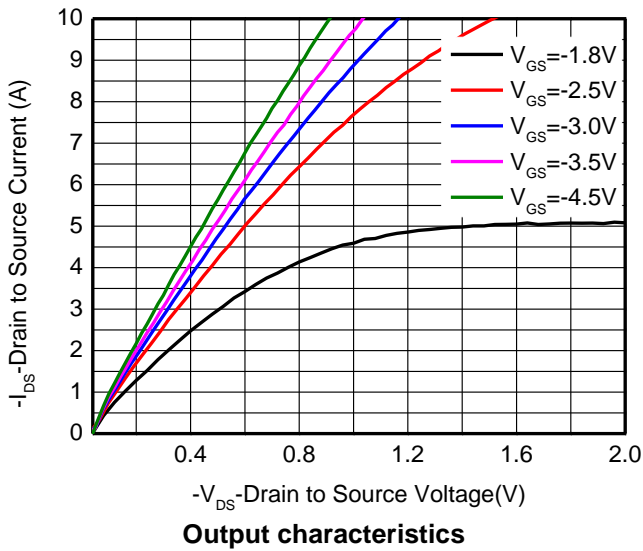
Symbol	Parameter	Test Condition	Min	Typ.	Max	Unit	
<b>Off Characteristics</b>							
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	N-Ch	20		V	
		$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	P-Ch	-20			
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=16\text{V}, V_{GS}=0\text{V}$	N-Ch		1	uA	
		$V_{DS}=-16\text{V}, V_{GS}=0\text{V}$	P-Ch		-1		
$I_{GSS}$	Gate –Source leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 8\text{V}$	N-Ch		$\pm 1$	uA	
			P-Ch		$\pm 1$		
<b>ON Characteristics</b>							
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	N-Ch		0.65	1.0	V
		$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	P-Ch		-0.70	-1.0	
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS}=4.5\text{V}, I_D=3.4\text{A}$	N-Ch		34	46	m $\Omega$
		$V_{GS}=-4.5\text{V}, I_D=-2.8\text{A}$	P-Ch		83	116	
		$V_{GS}=2.5\text{V}, I_D=3.0\text{A}$	N-Ch		41	69	
		$V_{GS}=-2.5\text{V}, I_D=-2.0\text{A}$	P-Ch		110	160	
<b>Dynamic Characteristics</b>							
$C_{iss}$	Input Capacitance	Nmos: $V_{DS}=10\text{V}, V_{GS}=0\text{V},$ $F=1\text{MHz}$	N-Ch		529	pF	
$C_{oss}$	Output Capacitance		P-Ch		531		
$C_{rss}$	Reverse Transfer Capacitance	Pmos: $V_{DS}=-10\text{V}, V_{GS}=0\text{V},$ $f=1\text{MHz}$	N-Ch		62		
			P-Ch		61		
$Q_{G(TOT)}$	Total Gate Charge	Nmos: $V_{DD}=10\text{V}, V_{GS}=4.5\text{V},$ $I_D=2.8\text{A}$	N-Ch		7.35	nC	
			P-Ch		5.8		
$Q_{G(TH)}$	Threshold gate charge	Pmos: $V_{DD}=-10\text{V}, V_{GS}=-4.5\text{V}$ $I_D=-2.8\text{A}$	N-Ch		0.75		
			P-Ch		0.82		
$Q_{GS}$	Gate-Source Charge		N-Ch		1.1		
			P-Ch		1.2		
$Q_{GD}$	Gate-Drain Charge		N-Ch		1.35		
			P-Ch		0.8		
$t_{d(on)}$	Turn-On Delay Time	Nmos: $V_{DD}=10\text{V}, V_{GS}=4.5\text{V},$ $I_D=1.0\text{A}, R_G=6\Omega$	N-Ch		18.6	ns	
$t_r$	Turn-On Rise Time		P-Ch		21.6		
$t_{d(off)}$	Turn-Off Delay Time	Pmos: $V_{DD}=-10\text{V}, I_D=-1.2\text{A},$ $V_{GS}=-4.5\text{V}, R_G=6\Omega$	N-Ch		8.2		
			P-Ch		8.6		
$t_f$	Turn-Off Fall Time		N-Ch		55		
			P-Ch		58		
<b>BODY DIODE CHARACTERISTICS</b>							
Forward Voltage	$V_{SD}$	$V_{GS}=0\text{V}, I_S=1.0\text{A}$	N-Ch		0.7	1.5	V
		$V_{GS}=0\text{V}, I_S=-1.0\text{A}$	P-Ch		-0.8	-1.5	

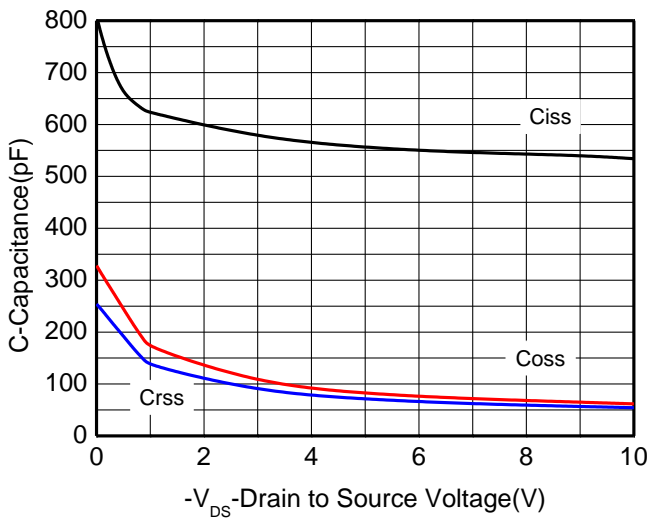
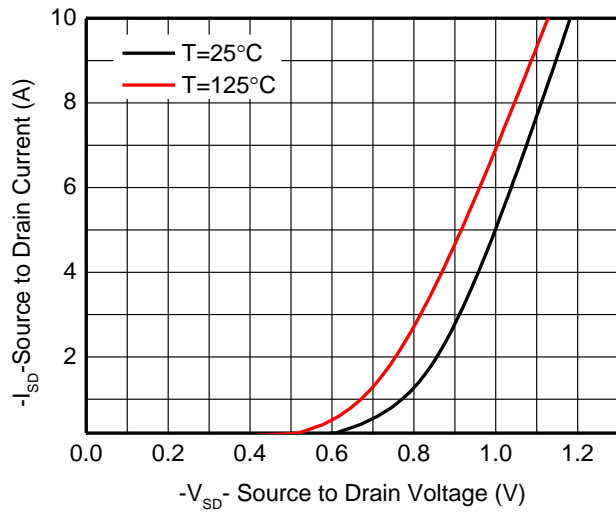
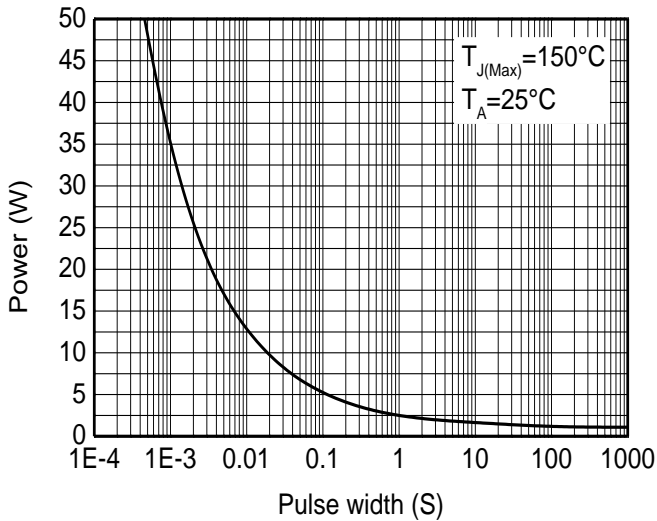
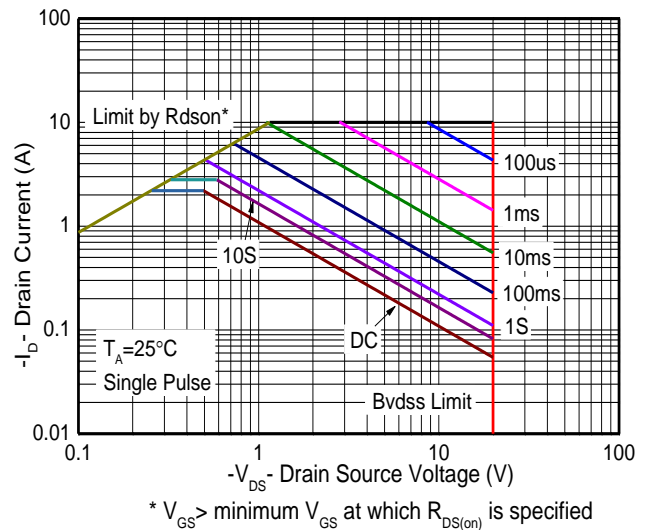
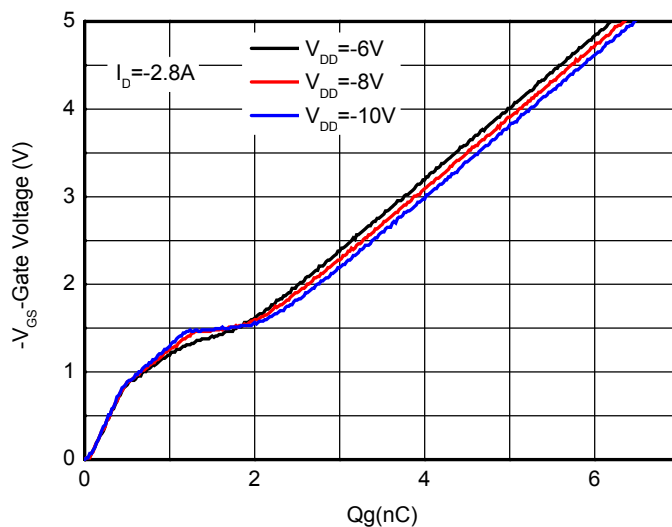
**Typical Characteristics (N-Channel  $T_A=25^\circ\text{C}$ , unless otherwise noted)**

**Output Characteristics**

**Transfer Characteristics**

**On-Resistance vs. Drain Current**

**On-Resistance vs. Gate-to-Source Voltage**

**On-Resistance vs. Junction Temperature**

**Threshold Voltage vs. Temperature**


**Capacitance**

**Body Diode Forward Voltage**

**Single pulse power**

**Safe operating power**

**Gate charge Characteristics**

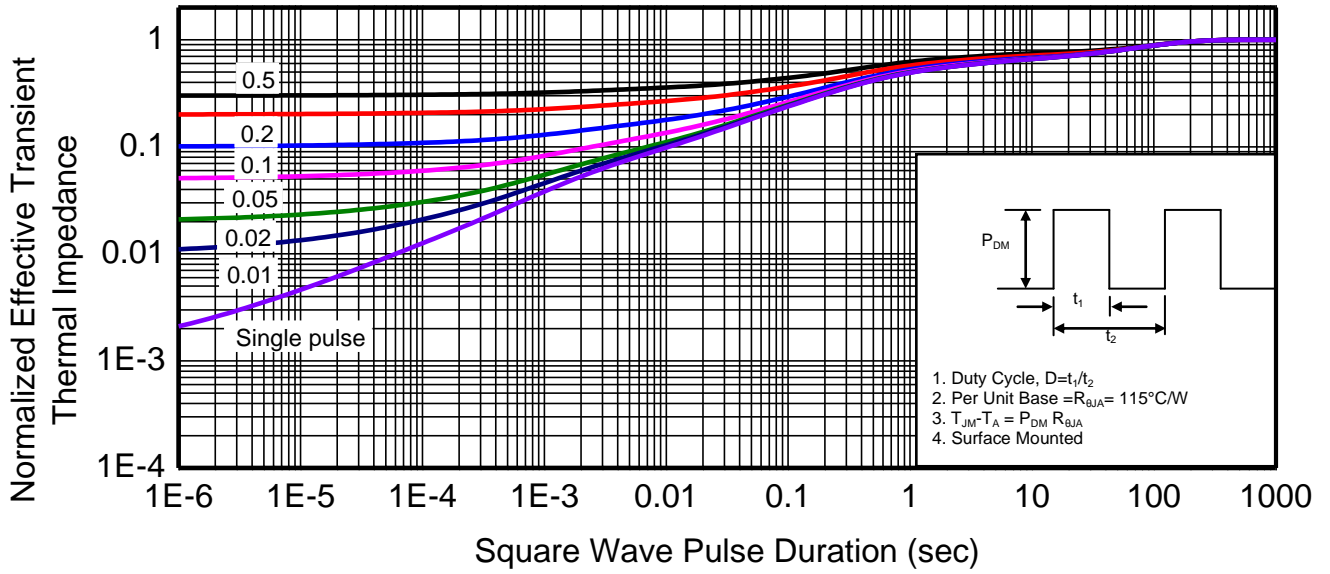


**Transient thermal response (Junction-to-Ambient)**

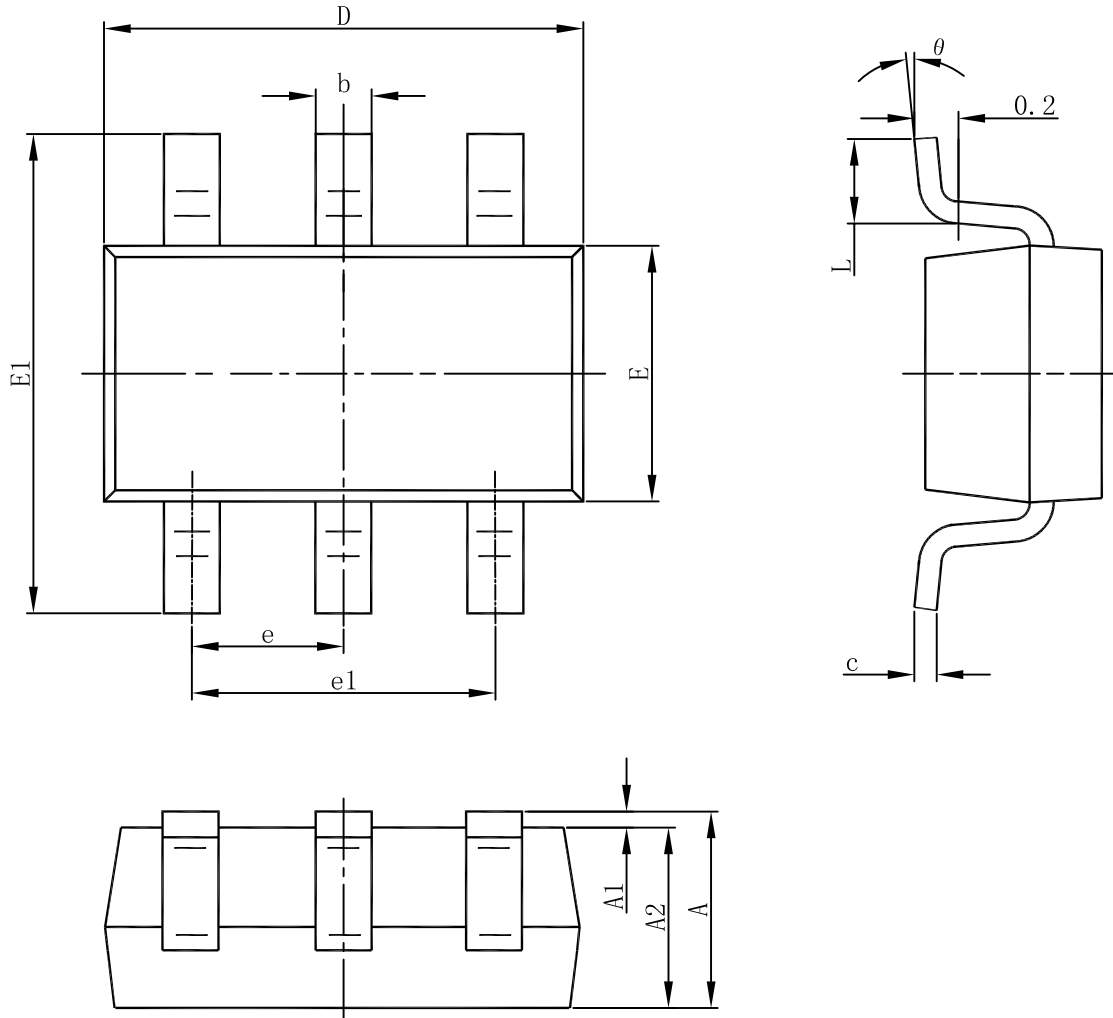
**Typical Characteristics (P-Channel  $T_A=25^\circ\text{C}$ , unless otherwise noted)**



**Capacitor**

**Body diode forward voltage**

**Single pulse power (Junction-to-ambient)**

**Safe operating power**

**Gate charge Characteristics**





### Transient thermal response (Junction-to-Ambient)

**Package Outline Dimension**
**SOT-23-6L**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
$\theta$	0°	8°	0°	8°